

L Number	Hits	Search Text	DB	Time stamp
1	711	mirror and barrier and adhesive and die	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 07:47
2	14	mirror and barrier and adhesive and die and gan	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 07:47
3	2	(backside back-side rear) WITH (reflector reflective reflecting mirror) and barrier and adhesive and die and gan	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 07:51
4	0	(backside back-side rear) WITH (reflector reflective reflection reflecting mirror) and corrosion and die and gan	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 07:51
5	73	(backside back-side rear) WITH (reflector reflective reflection reflecting mirror) and corrosion and die	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 08:21
6	95	(backside back-side rear) WITH (reflector reflective reflection reflecting mirror) and corrosion and (solder barrier adhesive) and (die chip)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 08:29
7	56	((backside back-side rear) WITH (reflector reflective reflection reflecting mirror) and corrosion and (solder barrier adhesive) and (die chip) ) not ((backside back-side rear) WITH (reflector reflective reflection reflecting mirror) and corrosion and die )	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 08:43
8	19	5192626.URPN.	USPAT	2002/08/31 08:37
9	183	(uemura-toshiya\$ nagasaka-naohisa\$ hashimura-masaki\$ hirano-atsuo\$ tadano-Hiroshi\$ kachi-tetsu\$ howokawa-hideki\$).in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 08:45
11	4	(uemura-toshiya\$ nagasaka-naohisa\$ hashimura-masaki\$ hirano-atsuo\$ tadano-Hiroshi\$ kachi-tetsu\$ hosokawa-hideki\$).in. and corrosion	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 08:46
12	22	(uemura-toshiya\$ nagasaka-naohisa\$ hashimura-masaki\$ hirano-atsuo\$ tadano-Hiroshi\$ kachi-tetsu\$ hosokawa-hideki\$).in. and (mirror reflect\$)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 08:49
10	213	(uemura-toshiya\$ nagasaka-naohisa\$ hashimura-masaki\$ hirano-atsuo\$ tadano-Hiroshi\$ kachi-tetsu\$ hosokawa-hideki\$).in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 09:07
13	1	("6335212").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 09:08
14	2	("5476884"   "5514627").PN.	USPAT	2002/08/31 09:08
15	241	(al aluminum) SAME (contact electrode) same (passivat\$ oxide) and gan	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 09:10
-	1285	(257/98).CCLS.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/29 10:43

-	828963	reflect\$3 mirror	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/29 10:43
-	735	((257/98).CCLS.) and (reflect\$3 mirror)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/29 11:31
-	8	("5217564"   "5502316"   "5620557"   "5641381"   "5679152"   "5804834"   "5846844"   "6046465").PN.	USPAT	2002/08/29 10:59
-	2	(("5952681") or ("6121636")).PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:07
-	1	6121636.URPN.	USPAT	2002/08/29 11:36
-	3	("3813587"   "5798537"   "5868951").PN.	USPAT	2002/08/29 11:36
-	2	5952681.URPN.	USPAT	2002/08/29 11:40
-	2	("5650641"   "5739552").PN.	USPAT	2002/08/29 11:40
-	4	("4857415"   "5641582"   "5828088"   "5977604").PN.	USPAT	2002/08/29 13:01
-	3	("4396929"   "4408217"   "4608581").PN.	USPAT	2002/08/29 13:14
-	5	("5146465"   "5226053"   "5247533"   "5369289"   "5493577").PN.	USPAT	2002/08/29 13:34
-	4	5862167.URPN.	USPAT	2002/08/29 13:34
-	16	("4445132"   "4447822"   "4553154"   "4875088"   "5181220"   "5281830"   "5483105"   "5554877"   "5571391"   "5587609"   "5652438"   "5701035"   "5798537"   "5862167"   "5864171"   "5905275").PN.	USPAT	2002/08/29 13:38
-	1	6201265.URPN.	USPAT	2002/08/29 13:41
-	0	(stelgerwald-daniel).in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:08
-	2	(stelgerwald-daniel\$).in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:10
-	297	(martin-paul\$ rudaz-serge\$ imler-william\$).in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:11
-	79	(martin-paul\$ rudaz-serge\$ imler-william\$).in. and light	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:18
-	1	(led same chip) and die near5 epoxy with (corrosion barrier)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:20
-	1	(led same lamp) and die near5 epoxy with (corrosion barrier)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:20
-	1	(led and chip) and die near5 epoxy with (corrosion barrier)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/30 00:20
-	7	dice and die near5 epoxy with (corrosion barrier)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2002/08/31 07:45

-	4	5895966.URPN.	USPAT	2002/08/30 00:23
-	8	("5095359"   "5196725"   "5220195"   "5311057"   "5366931"   "5386141"   "5468994"   "5508556").PN.	USPAT	2002/08/30 00:23